

TRIACS

- GLASS PASSIVATED CHIP
- IGT SPECIFIED IN FOUR QUADRANTS

ADVANTAGES

- EXCELLENT $(dv/dt)_c > 10 \text{ V}/\mu\text{s}$
- METALLIC ENCAPSULATION GIVES AN EXCELLENT THERMAL IMPEDANCE AND HIGH RELIABILITY CONSTRUCTION

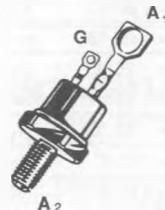
APPLICATIONS

- MOTOR CONTROL
- HEATING CONTROL
- LIGHT DIMMER

DESCRIPTION

Power triacs suited for use on 220 V and 380 V main.

Thread : 1/4" -28 UNF : type N°
M6 on request : type N° + suffix M



TO 48
(Metal)

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(\text{RMS})}$	RMS on-state Current (360° conduction angle)	35	A
I_{TSM}	Non Repetitive Surge Peak on-state Current (T_j initial = 25 °C - Half sine wave)	330	A
	$t = 8.3 \text{ ms}$	300	
I^2t	I^2t Value for Fusing	450	A^2s
di/dt	Critical Rate of Rise of on-state Current (1)	20	$\text{A}/\mu\text{s}$
		100	
T_{sig} T_i	Storage and Operating Junction Temperature Range	-40 to 150 -40 to 110	°C °C

Symbol	Parameter	TRAL				Unit
		1135D	2235D	3335D	3835D	
V_{DRM}	Repetitive Peak off-state Voltage (2)	200	400	600	700	V

(1) $I_G = 1.5 \text{ A}$ $di/dt = 1 \text{ A}/\mu\text{s}$

(2) $T_i = 110 \text{ °C}$.

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th} (c-h)$	Contact (case-heatsink) for Recommended Stud Torque	0.4	°C/W
$R_{th} (j-c)$ DC	Junction to Case for DC	1.12	°C/W
$R_{th} (j-c)$ AC	Junction to Case for 360 ° Conduction Angle ($F = 50 \text{ Hz}$)	0.84	°C/W

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 40 \text{ W}$ ($t_p = 10 \mu\text{s}$) $I_{GM} = 6 \text{ A}$ ($t_p = 10 \mu\text{s}$)
 $P_G(\text{AV}) = 1 \text{ W}$ $V_{GM} = 16 \text{ V}$ ($t_p = 10 \mu\text{s}$)

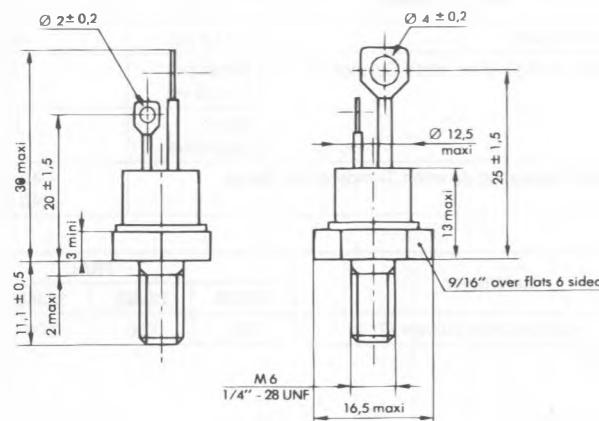
ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25^\circ\text{C}$ $V_D = 12 \text{ V}$ $R_L = 33 \Omega$ Pulse Duration > 20 μs	I-II-III			100	mA
		IV			150	
V_{GT}	$T_j = 25^\circ\text{C}$ $V_D = 12 \text{ V}$ $R_L = 33 \Omega$ Pulse Duration > 20 μs	I-II-III-IV			1.5	V
V_{GD}	$T_j = 110^\circ\text{C}$ $V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$	I-II-III-IV	0.2			V
I_H^*	$T_j = 25^\circ\text{C}$ $I_T = 500 \text{ mA}$ Gate Open				100	mA
I_L	$T_j = 25^\circ\text{C}$ $V_D = 12 \text{ V}$ $I_G = 300 \text{ mA}$ Pulse Duration > 20 μs	I-III-IV		60		mA
		II		120		
V_{TM}^*	$T_j = 25^\circ\text{C}$ $I_{TM} = 53 \text{ A}$ $t_p = 10 \text{ ms}$				2	V
I_{DRM}^*	$T_j = 110^\circ\text{C}$ V_{DRM} Specified				4	mA
dv/dt^*	$T_j = 110^\circ\text{C}$ Gate Open Linear Slope up to $V_D = 67\% V_{DRM}$		250			V/ μs
$(dv/dt)_c^*$	$T_C = 60^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 53 \text{ A}$ $(di/dt)_c = 15.5 \text{ A}/\text{ms}$		10			V/ μs
t_{gt}	$T_j = 25^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 53 \text{ A}$ $I_G = 200 \text{ mA}$ $di_G/dt = 2 \text{ A}/\mu\text{s}$	I-II-III-IV		3		μs

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

PACKAGE MECHANICAL DATA

TO 48 Metal



Cooling method : by conduction (method C)

Marking : type number

Weight : 13.5 ± 1 g

Polarity : anode to case

Stud torque : 3.5 mAN min - 3.8 mAN max.

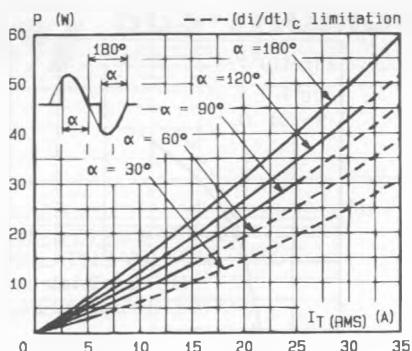


Fig.1 - Maximum mean power dissipation versus RMS on-state current ($f = 60$ Hz).

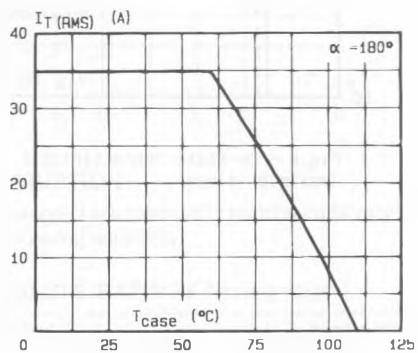


Fig.3 - RMS on-state current versus case temperature.

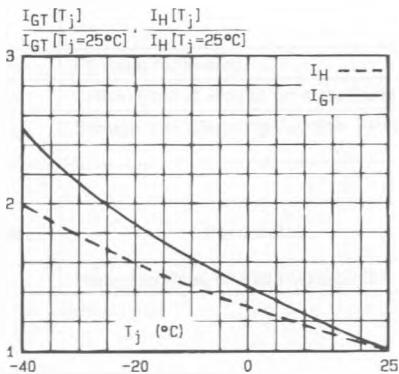


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

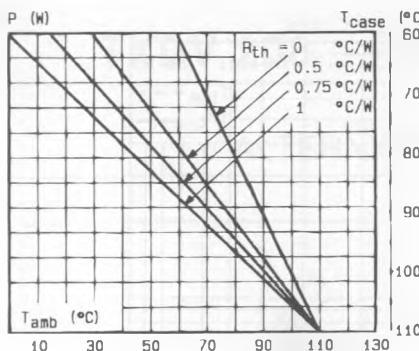


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

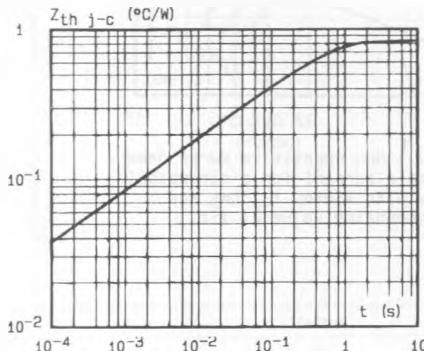


Fig.4 - Thermal transient impedance junction to case versus pulse duration.

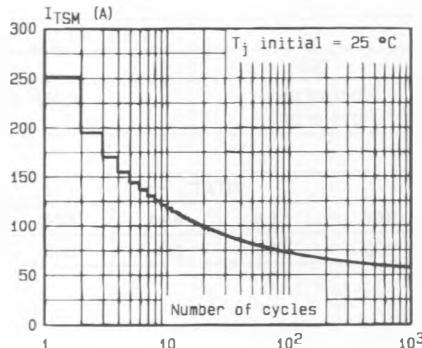


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

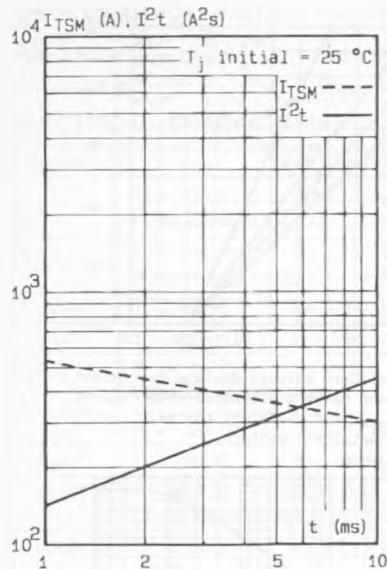


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width: $t \leq 10\text{ms}$, and corresponding value of I^2t .

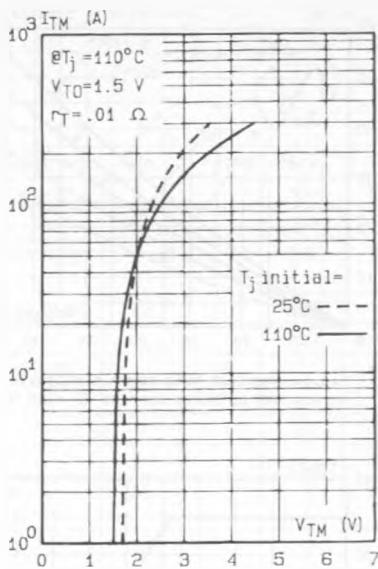


Fig.8 - On-state characteristic (maximum values).